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Pulse Proof Thick Film Chip Resistors

POWER

RATING

 P_{70}

0.063

0.10

0.125

0.25

0.50

0.75

1 0



STANDARD ELECTRICAL SPECIFICATIONS

CASE

SIZE

IMPERIAL

0402

0603

0805

1206

1210

2010

2512

CASE

SIZE

METRIC

RR1005M

RR1608M

RR2012M

RR3216M

RR3225M

RR5025M

RR6332M

FEATURES

- High pulse performance, up to 10 kW
- Stability $\Delta R/R \le 1$ % for 1000 h at 70 °C
- AEC-Q200 qualified

± 200

• Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



HALOGEN

FREE

| LIMITING ELEMENT VOLTAGE U _{max.} AC _{RMS} /DC V | TEMPERATURE COEFFICIENT ppm/K | TOLERANCE | RESISTANCE RANGE Ω | SERIES |
|---|-------------------------------------|-----------|--------------------------|--------|
| 50 | ± 200 | ± 5 | 1.0 to 100K | E24 |
| | 1 200 | ± 10 | 1.0 to 10010 | LLT |
| 75 | ± 200 | ± 5 | 1.0 to 100K | E24 |
| 73 | ± 200 | ± 10 | 1.0 to 10010 | L24 |
| 150 | ± 200 | ± 5 | 1.0 to 100K | E24 |
| 150 | ± 200 | ± 10 | 1.0 to 100K | ⊏24 |
| 200 | ± 200 | ± 5 | 1.0 to 100K | E24 |
| 200 | ± 200 | ± 10 | 1.0 to 100K | ⊏24 |
| 200 | . 200 | ± 5 | 1.0 to 100K | E24 |
| 200 | ± 200 | ± 10 | 1.0 to 100K | ⊏24 |
| 400 | ± 200 | ± 5 | 1.0 to 100K | E24 |
| 400 | ± 200 | ± 10 | 1.0 to 100K | ⊏24 |

± 10 ± 5

± 10

1.0 to 100K

F24

Notes

TYPE

D10/CRCW0402-IF

D11/CRCW0603-IF

D12/CRCW0805-IF

D25/CRCW1206-IF

CRCW1210-IF

CRCW2010-IF

CRCW2512-IF

These resistors do not feature a limited lifetime when operated within the limits of rated dissipation, permissible operating voltage, and permissible film temperature. However, the resistance typically increase due to the resistor's film temperature over operating time, generally known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional time.

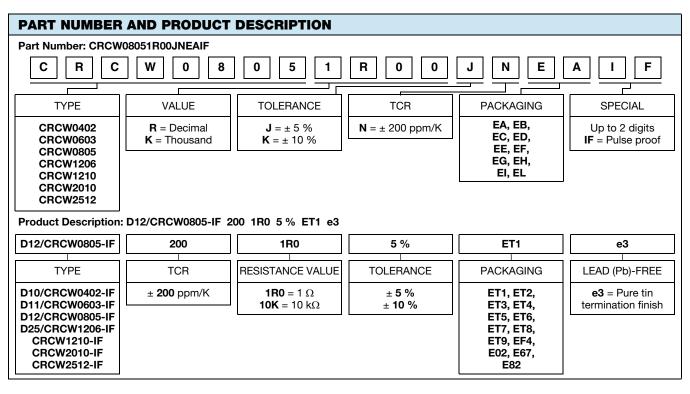
500

- Marking: See data sheet "Surface Mount Resistor Marking" (document number 20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

| TECHNICAL SPECIFICATIONS | | | | | | | | |
|--|-----------------|---------------------|----------------------------|---------------------|---------------------|-------------|-------------|-------------|
| PARAMETER | UNIT | D10/ CRCW0402-IF | D11/ CRCW0603-IF | D12/ CRCW0805-IF | D25/ CRCW1206-IF | CRCW1210-IF | CRCW2010-IF | CRCW2512-IF |
| Rated dissipation $P_{70}^{\ (1)}$ | W | 0.063 | 0.1 | 0.125 | 0.25 | 0.5 | 0.75 | 1.0 |
| Operating voltage U _{max.} AC _{RMS} /DC | ٧ | 50 | 75 | 150 | 200 | 200 | 400 | 500 |
| Insulation voltage U _{ins} (1 min) | ٧ | 75 | 100 | 200 | 300 | 300 | 300 | 300 |
| Insulation resistance | Ω | | > 109 | | | | | |
| Operating temperature range | °C | | -55 to +155 | | | | | |
| Failure rate | h ⁻¹ | | < 0.1 x 10 ⁻⁹ | | | | | |
| Mass | mg | 0.65 | 0.65 2 5.5 10 16 25.5 40.5 | | | | | |

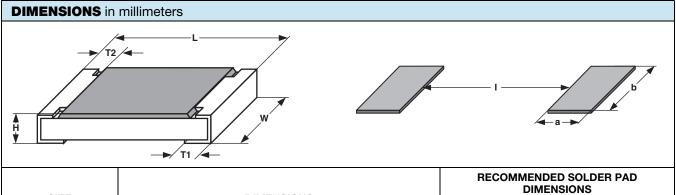
The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printe-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.





| PACKAGING | | | | | | | | |
|-----------------|----------|----------|--------------------------------|----------|----------|---------------|--|--|
| TYPE | CODE | QUANTITY | CARRIER TAPE | WIDTH | PITCH | REEL DIAMETER | | |
| D10/CRCW0402-IF | ED = ET7 | 10 000 | | 8 mm | 2 mm | 180 mm/7" | | |
| D10/ChCW0402-IF | EE = EF4 | 50 000 | | | | 330 mm/13" | | |
| | EI = ET2 | 5000 | 1 | | | 180 mm/7" | | |
| | ED = ET3 | 10 000 | | 8 mm | 2 mm | 180 mm/7" | | |
| | EL = ET4 | 20 000 | | 0 111111 | 2 111111 | 285 mm/11.25" | | |
| D11/CRCW0603-IF | EE = ET8 | 50 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | 1 | 8 mm | 4 mm | 180 mm/7" | | |
| | EB = ET5 | 10 000 | Paper tape acc. to IEC 60286-3 | | | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | Type 1a | 8 mm | 4 mm | 180 mm/7" | | |
| D12/CRCW0805-IF | EB = ET5 | 10 000 | | | | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | | | | 180 mm/7" | | |
| D25/CRCW1206-IF | EB = ET5 | 10 000 | | 8 mm | 4 mm | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 | | | | 330 mm/13" | | |
| | EA = ET1 | 5000 | | | 4 mm | 180 mm/7" | | |
| CRCW1210-IF | EB = ET5 | 10 000 | | 8 mm | | 285 mm/11.25" | | |
| | EC = ET6 | 20 000 |] | | | 330 mm/13" | | |
| CRCW2010-IF | EF = E02 | 4000 | Pressed tape | 12 mm | 4 mm | 180 mm/7" | | |
| ODOMOS10 IS | EG = E67 | 2000 | acc. to IEC 60286-3 | 10 | 8 mm | 100/7" | | |
| CRCW2512-IF | EH = E82 | 4000 | Type 1b | 12 mm | 4 mm | 180 mm/7" | | |

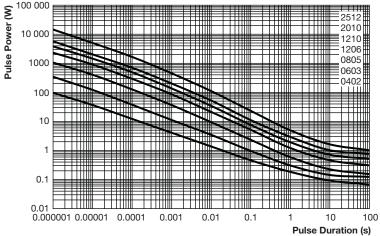




| SIZE | | DIMENSIONS | | | | RECOMMENDED SOLDER PAD DIMENSIONS | | | | | | |
|----------|---------|-------------------|-----------------|-----------------|-------------------|-----------------------------------|-----|-------------------|-----|-----|----------------|-----|
| 312 | | | DIMENSIONS | | | | _ | REFLOW DLDERIN | = | sc | WAVE LDERII | NG |
| IMPERIAL | METRIC | L | W | Н | T1 | T2 | а | b | ı | а | b | I |
| 0402 | RR1005M | 1.0 ± 0.05 | 0.5 ± 0.05 | 0.35 ± 0.05 | 0.25 ± 0.05 | 0.2 ± 0.1 | 0.4 | 0.6 | 0.5 | | | |
| 0603 | RR1608M | 1.55 + 0.10 | 0.85 ± 0.1 | 0.45 ± 0.05 | 0.3 ± 0.2 | 0.3 ± 0.2 | 0.5 | 0.9 | 1.0 | 0.9 | 0.9 | 1.0 |
| 0805 | RR2012M | 2.0 + 0.20 - 0.10 | 1.25 ± 0.15 | 0.45 ± 0.05 | 0.3 + 0.20 - 0.10 | 0.3 ± 0.2 | 0.7 | 1.3 | 1.2 | 0.9 | 1.3 | 1.3 |
| 1206 | RR3216M | 3.2 + 0.10 - 0.20 | 1.6 ± 0.15 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 1.7 | 2.0 | 1.1 | 1.7 | 2.3 |
| 1210 | RR3225M | 3.2 ± 0.2 | 2.5 ± 0.2 | 0.55 ± 0.05 | 0.45 ± 0.2 | 0.4 ± 0.2 | 0.9 | 2.5 | 2.0 | 1.1 | 2.5 | 2.2 |
| 2010 | RR5025M | 5.0 ± 0.15 | 2.5 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 2.5 | 3.9 | 1.2 | 2.5 | 3.9 |
| 2512 | RR6332M | 6.3 ± 0.2 | 3.15 ± 0.15 | 0.6 ± 0.1 | 0.6 ± 0.2 | 0.6 ± 0.2 | 1.0 | 3.2 | 5.2 | 1.2 | 3.2 | 5.2 |

FUNCTIONAL PERFORMANCE

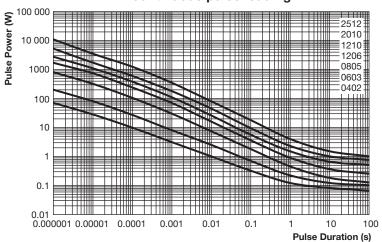
Maximum pulse dissipation as a function of the pulse duration, single pulse



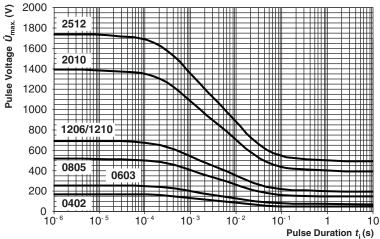
Maximum pulse load, single pulse; applicable if $\vec{P} \rightarrow 0$ and $n \le 1000$ and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation



Maximum pulse dissipation as a function of the pulse duration, continuous pulse loading



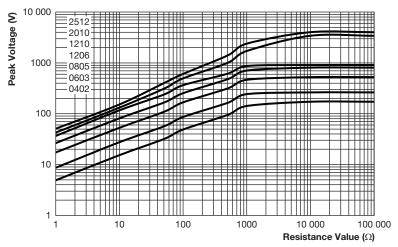
Maximum pulse load, continuous pulses; applicable if $P \le P(\vartheta_{amb})$ and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation

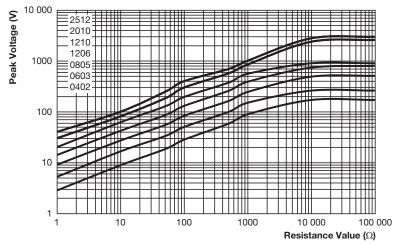


Single-pulse high voltage overload test 1.2 µs/50 µs EN 140000 4.27



Pulse load rating in accordance to EN 60115-1, 4.27; 1.2 μ s/50 μ s; 5 pulses at 12 s intervals; for permissible resistance change 1 %

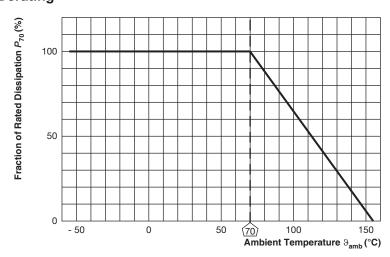
Single-pulse high voltage overload test 10 μ s/700 μ s EN 140000 4.27



Pulse load rating in accordance to EN 60115-1, 4.27; 10 μ s/700 μ s; 10 pulses at 1 min intervals; for permissible resistance change 1 %



Derating



| | IEC | | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (ΔR) | |
|---------------|----------|--|---|---|--|
| EN 60115-1 | 60082-2 | TEST | | STABILITY CLASS 1 OR BETTER | |
| CLAUSE | METHOD | TEST LEST ETHOD | Stability for product type: | 1 O to 100 kg | |
| | | | D/CRCW-IF e3 | 1 Ω to 100 k Ω | |
| 4.5 | - | Resistance | - | ± 5 %; ± 10 % | |
| 4.7 | - | Voltage proof | $U = 1.4 \times U_{ins}$; 60 s | No flashover or breakdown | |
| 4.13 | - | Short time overload | $U = 2.5 \times \sqrt{P_{70} \times R} \le 2 \times U_{\text{max.}};$ duration acc. to style | ± (0.25 % R + 0.05 Ω) | |
| | | Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C, (2 ± 0.2) s | Good tinning (≥ 95 % covered); no visible damage | | |
| 4.17.2 | 58 (Td) | Solderability | Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 ± 5) °C, (3 ± 0.3) s | Good tinning (≥ 95 % covered); no visible damage | |
| 4.8.4.2 | - | Temperature coefficient | (20/- 55/20) °C and (20/125/20) °C | ± 200 ppm/K | |
| 4.19 14 (1 | 14 (Na) | 14 (Na) Rapid change of temperature | 30 min. at - 55 °C; 30 min. at 125°C | | |
| | 14 (IVa) | | 5 cycles 1000 cycles | $\pm (0.25 \% R + 0.05 \Omega)$ $\pm (1 \% R + 0.05 \Omega)$ | |

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| TEST P | TEST PROCEDURES AND REQUIREMENTS | | | | | | | | |
|---------|----------------------------------|--|--|--|--|--|--|--|--|
| EN | IEC | | PROCEDURE | REQUIREMENTS PERMISSIBLE CHANGE (ΔR) STABILITY CLASS 1 OR BETTER | | | | | |
| 60115-1 | 600923 | TEST | | | | | | | |
| CLAUSE | METHOD | | Stability for product type: | 1 Ω to 100 kΩ | | | | | |
| | | | D/CRCW-IF e3 | 1 75 fO 100 k75 | | | | | |
| 4.23 | - | Climatic sequence: | - | | | | | | |
| 4.23.2 | 2 (Ba) | Dry heat | 125 °C; 16 h | | | | | | |
| 4.23.3 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 1 cycle | | | | | | |
| 4.23.4 | 1 (Aa) | Cold | - 55 °C; 2 h | $\pm (1 \% R + 0.05 \Omega)$ | | | | | |
| 4.23.5 | 13 (M) | Low air pressure | 1 kPa; (25 ± 10) °C; 1 h | | | | | | |
| 4.23.6 | 30 (Db) | Damp heat, cyclic | 55 °C; ≥ 90 % RH; 24 h; 5 cycles | | | | | | |
| 4.23.7 | - | DC load | $U = \sqrt{P_{70} \times R}$ | | | | | | |
| 4.25.1 | - | Endurance at 70 °C | $U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h | ± (1 % R + 0.05 Ω) ± (2 % R + 0.1 Ω) | | | | | |
| 4.18.2 | 58 (Td) | Resistance to soldering heat | Solder bath method (260 ± 5) °C; (10 ± 1) s | ± (0.25 % R + 0.05 Ω) | | | | | |
| 4.24 | 78 (Cab) | Damp heat, steady state | (40 ± 2) °C; (93 ± 3) % RH; 56 days | ± (1 % R + 0.05 Ω) | | | | | |
| 4.25.3 | - | Endurance at upper category temperature | 155 °C; 1000 h | ± (1 % R + 0.05 Ω) | | | | | |
| 4.27 | - | Single pulse high voltage overload, 10 µs/700 µs | $\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}};$ 10 pulses | ± (1 % R + 0.05 Ω) | | | | | |

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.

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